



S 690 T

T-31-19

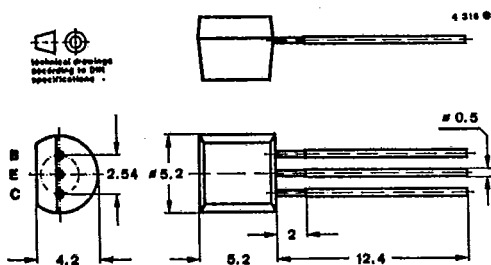
**Silicon NPN Planar RF Transistor**

**Applications:** RF amplifier up to GHz range specially for wide band antenna amplifier

**Features:**

- High power gain
- High transition frequency
- Low noise figure

**Dimensions in mm**



Case  
10 A 3 DIN 41868  
JEDEC TO 92  
Weight max. 0.2 g

**Absolute maximum ratings**

Collector-base voltage	$V_{CBO}$	20	V
Collector-emitter voltage	$V_{CEO}$	15	V
Emitter-base voltage	$V_{EBO}$	2	V
Collector current	$I_C$	30	mA
Total power dissipation $T_{amb} = 25\text{ }^\circ\text{C}$ , see page A 24, Fig. 6.1	$P_{tot}$	450	mW
Junction temperature	$T_J$	150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-65 ... +150	$^\circ\text{C}$

**Thermal resistances**

	Min.	Typ.	Max.
Junction ambient see page A 24, Fig. 6.1			275 K/W

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## DC characteristics

Min. Typ. Max.

 $T_j = 25^\circ\text{C}$ , unless otherwise specified

Collector cut-off current

 $V_{CB} = 10\text{ V}, I_E = 0$  $I_{CBO}$ 

50 nA

Collector-base breakdown voltage

 $I_C = 10\ \mu\text{A}$  $V_{(BR)CBO}$ 

20

V

Collector-emitter breakdown voltage

 $I_C = 2\text{ mA}$  $V_{(BR)CEO}$ 

15

V

Emitter-base breakdown voltage

 $I_E = 10\ \mu\text{A}$  $V_{(BR)EBO}$ 

2

V

DC forward current transfer ratio

 $I_C = 14\text{ mA}, V_{CE} = 10\text{ V}$  $h_{FE}$ 

25

90

## AC characteristics

 $T_{amb} = 25^\circ\text{C}$ 

Gain bandwidth product

 $I_C = 14\text{ mA}, V_{CE} = 10\text{ V}, f = 500\text{ MHz}$  $f_T$ 

5

GHz

Feedback capacitance

 $I_C = 2\text{ mA}, V_{CE} = 10\text{ V}, f = 1\text{ MHz}$  $C_{0re}$ 

0.4

pF

Collector-base capacitance

 $V_{CB} = 10\text{ V}, f = 1\text{ MHz}$  $C_{CBO}$ 

0.5

pF

Emitter-base capacitance

 $V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}$  $C_{EBO}$ 

0.8

pF

Noise figure

 $I_C = 2\text{ mA}, V_{CE} = 10\text{ V}, f = 500\text{ MHz}$  $R_G = R_{Gopt}$  $F$ 

2.4

dB

7. Taping and Reeling

T-91-20

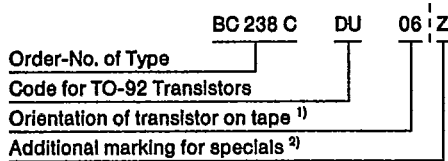
7.1. Taping of TO-92 Transistors

Standard reeling: Taped on reel, reeled together with a paper film.

7.1.1. Order Numbers

Add the taping-code to the order number.

Example:



- <sup>1)</sup> 06 = View on flat side of transistor, view on gummed tape
- 05 = View on round side of transistor, view on gummed tape

- <sup>2)</sup> Additional marking "0": taping without paper film
- Additional marking "Z": Zigzag folded tape in special box. Marking for orientation of transistor not necessary, because box can be opened on top or bottom

Example for order No.: BC 237 C DU Z

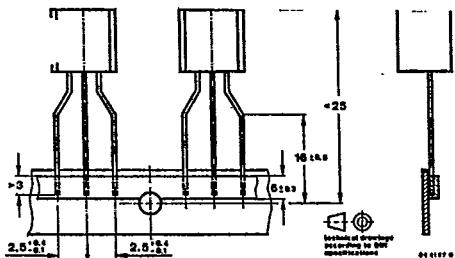


Fig. 7.3 Dimensions of tape in mm

7.1.2 Quantity of devices

- 1 000 devices per reel
- 2 000 devices per folded tape in special box.

7.2. Taped transistors in SOT 23 and SOT 143 case

7.2.1. Designation

a) Standard taping

Designation is attached with code GS 08 in case of standard taping. Example for normal version transistors as standard taped: BF 569-GS 08.

Example for R-version transistors as standard taped: BF 569 R-GS 08.

In case of standard taping, the transistor orientation on the tape is shown in Fig. 7.4 and Fig. 7.5.

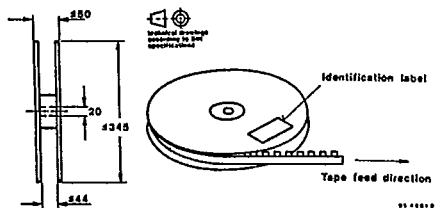


Fig. 7.1. Dimensions of reel in mm

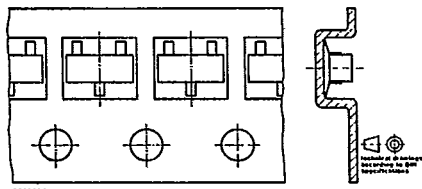


Fig. 7.4 Standard taped SOT 23

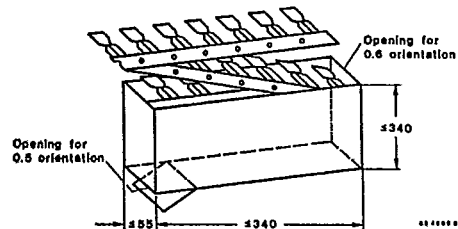


Fig. 7.2. Dimension of box for Zigzag folding in mm

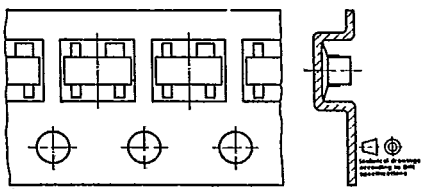


Fig. 7.5. Standard taped SOT 143

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b) Reverse taping

Designation is attached with code GS07 in case of reverse taping. Example for normal version transistors as reverse taped: BF 569-GS 07.

Example for R-version transistors as reverse taping: BF 569 R-GS 07.

In case of reverse taping, the transistor orientation on the tape is shown in Fig. 7.6.

Regarding MOS-FET and MES-FET devices, reverse taping is at present not available.

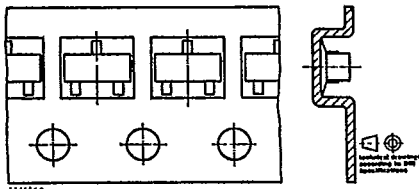


Fig. 7.6 Reverse taped SOT 23

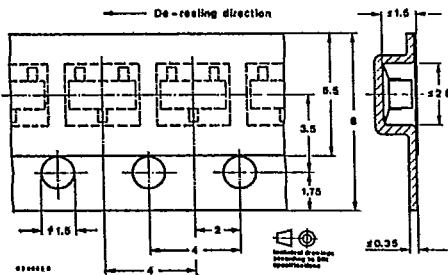


Fig. 7.7 Dimensions of tape in mm

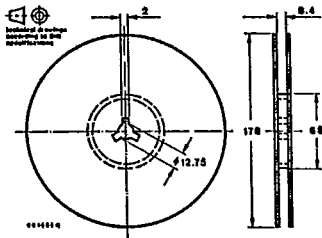


Fig. 7.8 Dimensions of reel in mm

7.2.2 Quantity of devices

3000 devices per reel